

# GDM7243S

## Cat4 VoLTE FDD-TDD LTE Single Chip

**GCT's Single Chip Advantage:  
RF + Baseband on a Single Chip**

### Features

- Cat4 LTE: 150 Mbps downlink, 50 Mbps uplink
- 3GPP Release 9
- On-Chip VoLTE, eMBMS
- TDD and FDD: Supports all frequency bands
- IMS, OTA-DM, etc. integrated
- Seamless handover between FDD and TDD-LTE
- Hostless stand-alone (CPE, USB Dongle, M2M)
- Complete LTE protocol stack and host software
- Global LTE roaming (multi-band support: >8 bands simultaneously)



### Interfaces

- |                          |        |
|--------------------------|--------|
| • USB2 (Device & Host)   | • I2S  |
| • SDIO 3 (Device & Host) | • PCM  |
| • HSI                    | • NAND |
| • SPI                    | • UART |
| • E-MEM                  | • GPIO |
| • R-GMII                 | • SIM  |

### Package Outline

- 12x12x1.2 mm BGA package
- Integrated memory optional

### Key Benefits

- Low Power Consumption
- High Integration (BB, RF), lower cost of ownership
- Turnkey VoLTE, eMBMS, etc.
- High Performance
- Inter and Intra-band Capability

### Applications

- Smartphones, Tablets, etc.
- Mobile Hotspots, CPEs
- USB Dongles
- M2M Modules
- Ultrabooks, Chromebooks
- Datacards

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